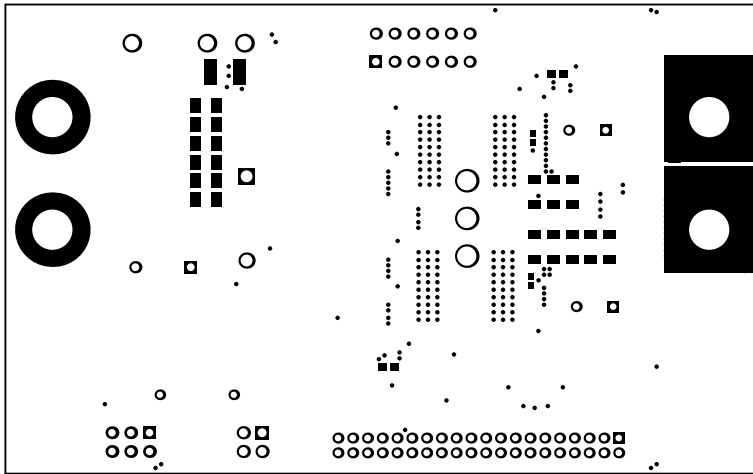
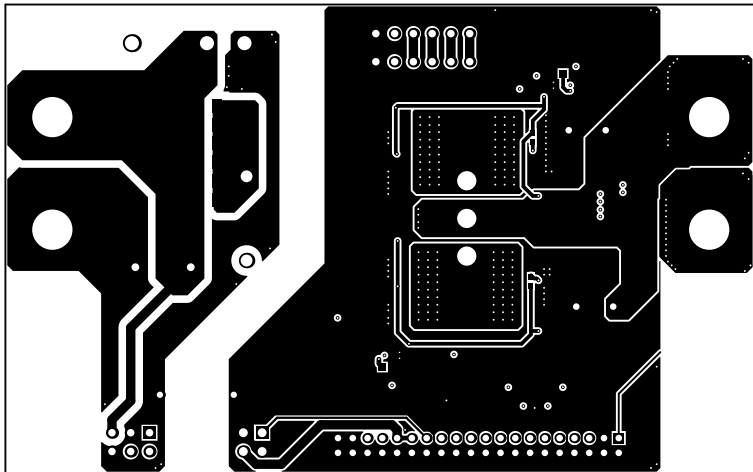


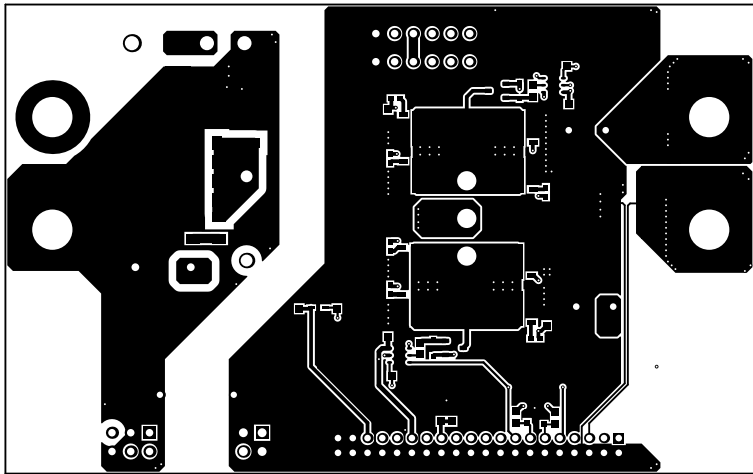
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 1/29/2019 10:52:41 AM	TEXAS INSTRUMENTS	



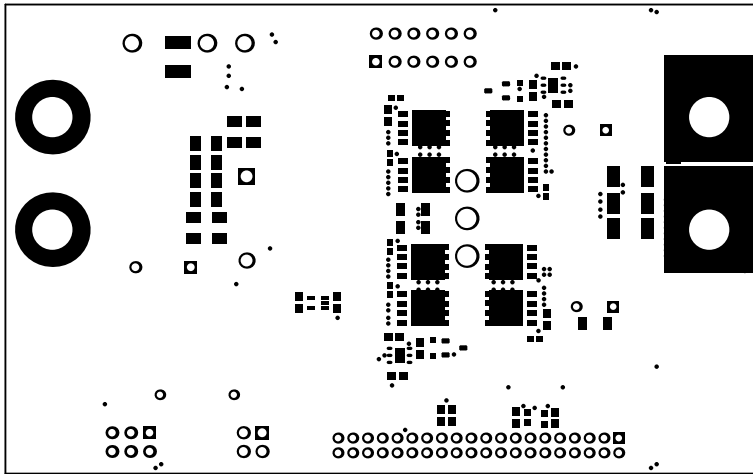
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 1/29/2019 10:52:42 AM	TEXAS INSTRUMENTS	



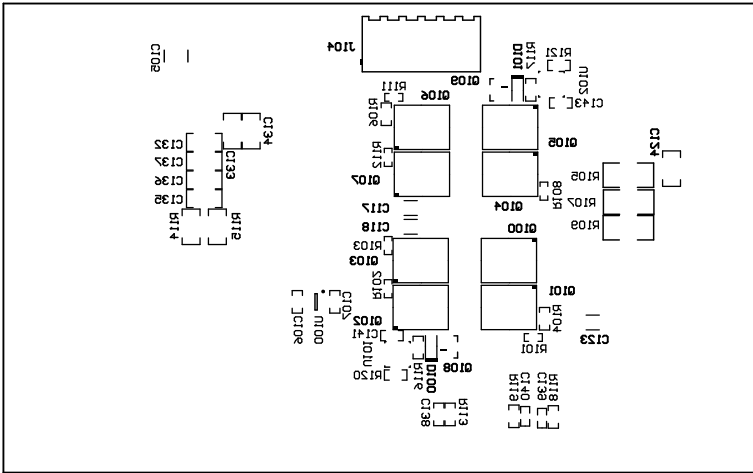
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 1/29/2019 10:52:44 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 1/29/2019 10:52:45 AM	TEXAS INSTRUMENTS	

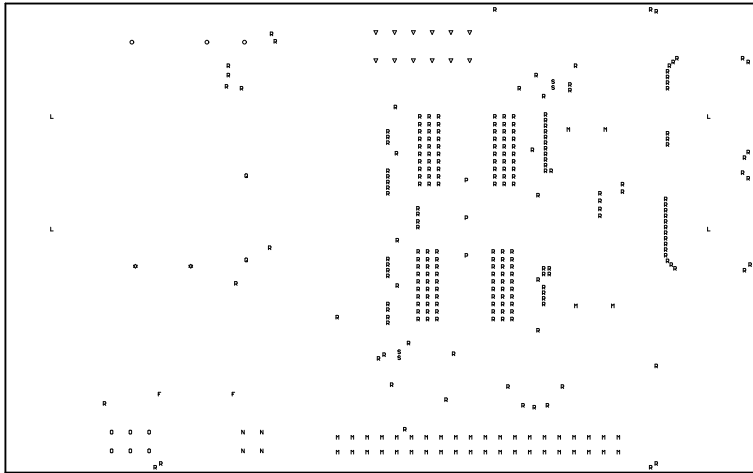


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/29/2019 10:52:46 AM	TEXAS INSTRUMENTS	

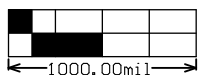
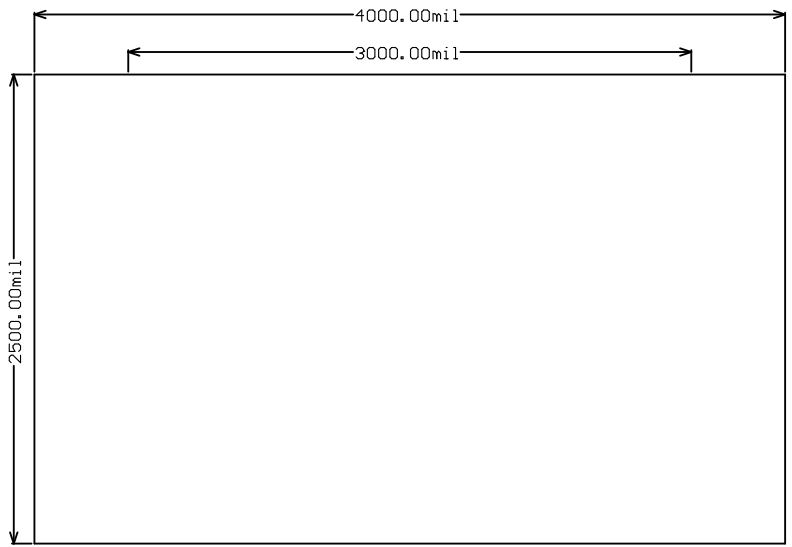


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 1/29/2019 10:52:48 AM	TEXAS INSTRUMENTS	

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
F	2	33.47mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c135h85			
☆	2	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
Q	2	62.99mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
O	3	75.00mil (1.905mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c245h190			
P	3	102.36mil (2.600mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c310h260			
S	4	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v50h20			
N	4	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
L	4	214.57mil (5.450mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c1000h545			
O	6	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
∇	12	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
M	44	35.00mil (0.889mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)			
R	242	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v51h25			
	328 Total										



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 1/29/2019 10:52:49 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21842	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 1/29/2019 10:52:51 AM	TEXAS INSTRUMENTS	

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